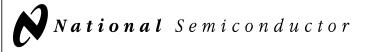
November 1999



## LM83 Triple-Diode Input and Local Digital Temperature Sensor with Two-Wire Interface

### **General Description**

The LM83 is a digital temperature sensor with a 2 wire serial interface that senses the voltage and thus the temperature of three remote diodes using a Delta-Sigma analog-to-digital converter with a digital over-temperature detector. The LM83 accurately senses its own temperature as well as the temperature of three external devices, such as Pentium II® Processors or diode connected 2N3904s. The temperature of any ASIC can be detected using the LM83 as long as a dedicated diode (semiconductor junction) is available on the die. Using the SMBus interface a host can access the LM83's registers at any time. Activation of a T\_CRIT\_A output occurs when any temperature is greater than a programmable comparator limit, T\_CRIT. Activation of an INT output occurs when any temperature is greater than its corresponding programmable comparator HIGH limit.

The host can program as well as read back the state of the T\_CRIT register and the four T\_HIGH registers. Three state logic inputs allow two pins (ADD0, ADD1) to select up to 9 SMBus address locations for the LM83. The sensor powers up with default thresholds of  $127^{\circ}$ C for T\_CRIT and all T\_HIGHs. The LM83 is pin for pin and register compatible with the LM84 as well as the Maxim MAX1617 and the Analog Devices ADM1021.

### Features

 Accurately senses die temperature of 3 remote ICs, or diode junctions

- On-board local temperature sensing
- SMBus and I<sup>2</sup>C compatible interface, supports SMBus 1.1 TIMEOUT
- Two interrupt outputs: INT and T\_CRIT\_A
- Register readback capability
- 7 bit plus sign temperature data format, 1 °C resolution
- 2 address select pins allow connection of 9 LM83s on a single bus

### **Key Specifications**

|   | Supply Voltage | 3.0V to 3.6V |
|---|----------------|--------------|
| _ |                |              |

- Supply Current 0.8mA (max)
- Local Temp Accuracy (includes quantization error)

0°C to +85°C ±3.0°C (max)

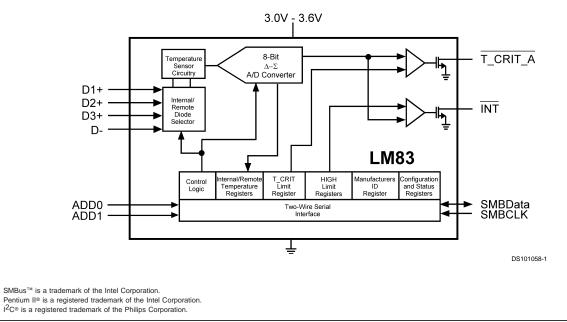
Remote Diode Temp Accuracy (includes quantization error)

| +25°C to +100°C | ±3°C (max) |
|-----------------|------------|
| 0°C to +125°C   | ±4°C (max) |

### Applications

- System Thermal Management
- Computers
- Electronic Test Equipment
- Office Electronics
- HVAC

## Simplified Block Diagram



D3+ \_ 5

ADD1 — 6

GND — 7 GND — 8 - T\_CRIT\_A

- SMBCLK

- SMBData

DS101058-2

- NC

– NC

- INT

– NC

- ADD0

12

11

10

9

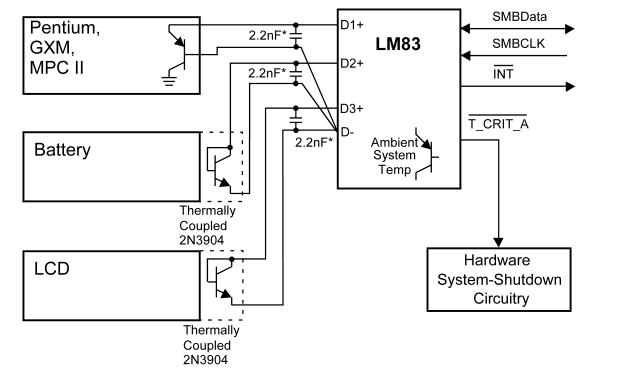
TOP VIEW

LM83



| Order<br>Number | NS<br>Package<br>Number | Transport<br>Media                |
|-----------------|-------------------------|-----------------------------------|
| LM83CIMQA       | MQA16A<br>(QSOP-16)     | 95 Units in<br>Rail               |
| LM83CIMQAX      | MQA16A<br>(QSOP-16)     | 2500 Units on<br>Tape and<br>Reel |

### **Typical Application**



\*Note: 2.2nF Capacitors must be placed as close as possilbe to D+ and D- pins of the LM83.

DS101058-3

### **Pin Description**

| Label Pin #     |         | Function                         | Typical Connection  |  |  |
|-----------------|---------|----------------------------------|---|--|--|
| D1+, D2+, D3+   | 1, 3, 5 | Diode Current Source             | To Diode Anode. Connected to remote discrete<br>diode junction or to the diode junction on a remote<br>IC whose die temperature is being sensed. When<br>not used they should be left floating. |  |  |
| V <sub>cc</sub> | 2       | Positive Supply Voltage<br>Input | DC Voltage from 3.0 V to 3.6 V  |  |  |

| Pin Description (Continued) |           |   |   |  |  |  |
|-----------------------------|-----------|---|---|--|--|--|
| Label                       | Pin #     | Function  | Typical Connection  |  |  |  |
| D-                          | 4         | Diode Return Current<br>Sink  | To all Diode Junction Cathodes using a star connection to pin. Must float when not used.  |  |  |  |
| ADD0-ADD1                   | 10, 6     | User-Set SMBus (I <sup>2</sup> C)<br>Address Inputs                               | Ground (Low, "0"), V <sub>CC</sub> (High, "1") or open<br>("TRI-LEVEL")   |  |  |  |
| GND                         | 7, 8      | Power Supply Ground   | Ground  |  |  |  |
| NC                          | 9, 13, 15 | Manufacturing test pins.  | Left floating. PC board traces may be routed<br>through the pads for these pins, although the<br>components that drive these traces should share<br>the same supply as the LM83 so that the Absolute<br>Maximum Rating, Voltage at Any Pin, is not<br>violated. |  |  |  |
| ĪNT                         | 11        | Interrupt Output,<br>open-drain   | Pull Up Resistor, Controller Interrupt or Alert Line  |  |  |  |
| SMBData                     | 12        | SMBus (I <sup>2</sup> C) Serial<br>Bi-Directional Data Line,<br>open-drain output | From and to Controller, Pull-Up Resistor  |  |  |  |
| SMBCLK                      | 14        | SMBus (I <sup>2</sup> C) Clock Input  | From Controller, Pull-Up Resistor   |  |  |  |
| T_CRIT_A                    | 16        | Critical Temperature<br>Alarm, open-drain output                                  | Pull Up Resistor, Controller Interrupt Line or<br>System Shutdown   |  |  |  |

LM83

LM83

### Absolute Maximum Ratings (Note 1)

| Absolute Maximum Rati  | ngs (Note 1)  | QSOP Package (Note 3)  |                        |
|--|---|--|------------------------|
| Supply Voltage<br>Voltage at Any Pin   | -0.3 V to 6.0 V<br>-0.3 V to<br>(V <sub>CC</sub> + 0.3 V) | Vapor Phase (60 seconds)<br>Infrared (15 seconds)<br>ESD Susceptibility (Note 4) | 215°C<br>220°C         |
| D– Input Current   | ±1 mA   | Human Body Model   | 2000 V                 |
| Input Current at All Other Pins (Note<br>2)<br>Package Input Current (Note 2)<br>SMBData, T_CRIT_A, INT Output | 5 mA<br>20 mA   | Machine Model Operating Ratings (Notes 1, 5)                                     | 200 V                  |
|  | 10 mA   | Specified Temperature Range  | $T_{MIN}$ to $T_{MAX}$ |
| SMBCLK, SMBData, T_CRIT_A, INT<br>Output Voltage   | 6.0 V   | LM83   | -40°C to +125°C        |
| Storage Temperature  | –65°C to +150°C   | Supply Voltage Range (V <sub>CC</sub> )  | +3.0V to +3.6V         |
| Soldering Information, Lead Temperatur   | e   |  |                        |

**Temperature-to-Digital Converter Characteristics** Unless otherwise noted, these specifications apply for  $V_{CC}$ =+3.0Vdc to 3.6Vdc. Boldface limits apply for  $T_A = T_J = T_{MIN}$  to  $T_{MAX}$ ; all other limits  $T_A = T_J = +25$ °C, unless otherwise noted.

| Parameter  | Conditions   | Typical  | Limits   | Units    |
|--|--|----------|----------|----------|
|  |  | (Note 6) | (Note 7) | (Limit)  |
| Temperature Error using Local                                    | $T_A = 0$ °C to +85°C,   | ±1       | ±3       | °C (max) |
| Diode ((Note 8))   | V <sub>CC</sub> =+3.3V   |          |          |          |
|  | $T_A = -40 \text{ °C to } +125 \text{ °C},$<br>$V_{CC} = +3.3 \text{ V}$ |          | ±4       | °C (max) |
| Temperature Error using Remote<br>Diode ((Note 8))               | $T_A = +60 \degree C \text{ to } +100\degree C,$<br>$V_{CC}=+3.3V$       |          | ±3       | °C (max) |
|  | $T_A = 25 \ ^{\circ}C \ to +100 \ ^{\circ}C,$<br>$V_{CC}=+3.3V$          |          | ±3       | °C (max) |
|  | $T_A = 0$ °C to +125°C,<br>$V_{CC}$ =+3.3V                               |          | ±4       | °C (max) |
| Diode Channel to Channel Matching                                |  | 0        |          | °C       |
| Resolution   |  | 8        |          | Bits     |
|  | Γ  | 1        |          | °C       |
| Conversion Time of All<br>Temperatures                           | (Note 10)  | 460      | 600      | ms (max) |
| Quiescent Current (Note 9)                                       | SMBus (I <sup>2</sup> C) Inactive  | 0.500    | 0.80     | mA (max) |
| D- Source Voltage  |  | 0.7      |          | V        |
| Diode Source Current   | (D+ – D–)=+ 0.65V; high  |          | 125      | μA (max) |
|  | level  |          | 60       | μA (min) |
|  | Low level  |          | 15       | μA (max) |
|  |  |          | 5        | μA (min) |
| T_CRIT_A and INT Output<br>Saturation Voltage                    | I <sub>OUT</sub> = 3.0 mA  |          | 0.4      | V (max)  |
| Power-On Reset Threshold   | On V <sub>CC</sub> input, falling  |          | 2.3      | V (max)  |
|  | edge   |          | 1.8      | V (min)  |
| Local and Remote T_CRIT and<br>HIGH Default Temperature settings | (Note 11)  | +127     |          | °C       |

# LM83

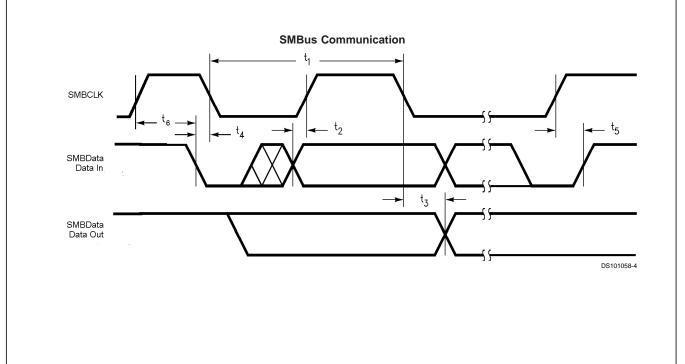
**Logic Electrical Characteristics DIGITAL DC CHARACTERISTICS** Unless otherwise noted, these specifications apply for  $V_{CC}$ =+3.0 to 3.6 Vdc. **Boldface limits apply for T<sub>A</sub> = T<sub>J</sub> = T<sub>MIN</sub> to T<sub>MAX</sub>; all other limits** T<sub>A</sub> = T<sub>J</sub>=+25°C, unless otherwise noted.

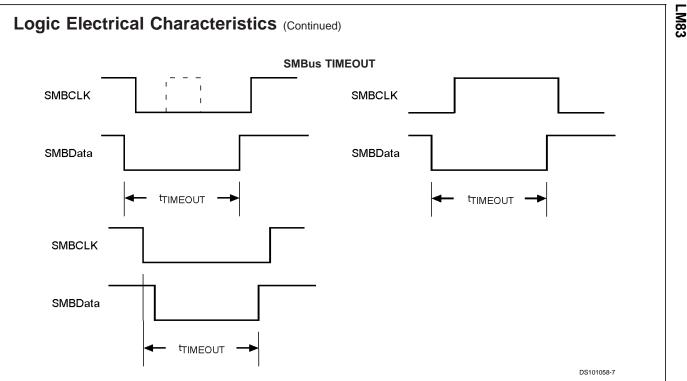
| Symbol                | Parameter                                   | Conditions              | Typical         | Limits   | Units    |  |
|-----------------------|---|-------------------------|-----------------|----------|----------|--|
|                       |   |                         | (Note 6)        | (Note 7) | (Limit)  |  |
| SMBData, SI           | MBCLK                                       | •                       | •               |          |          |  |
| V <sub>IN(1)</sub>    | Logical "1" Input Voltage                   |                         |                 | 2.1      | V (min)  |  |
| V <sub>IN(0)</sub>    | Logical "0"Input Voltage                    |                         |                 | 0.8      | V (max)  |  |
| V <sub>IN(HYST)</sub> | SMBData and SMBCLK Digital Input Hysteresis |                         | 300             |          | mV       |  |
| I <sub>IN(1)</sub>    | Logical "1" Input Current                   | $V_{IN} = V_{CC}$       | 0.005           | 1.5      | μA (max) |  |
| I <sub>IN(0)</sub>    | Logical "0" Input Current                   | $V_{IN} = 0 V$          | -0.005          | 1.5      | μA (max) |  |
| ADD0, ADD1            |   | 1                       |                 |          |          |  |
| V <sub>IN(1)</sub>    | Logical "1" Input Voltage                   |                         | V <sub>cc</sub> | 1.5      | V (min)  |  |
| V <sub>IN(0)</sub>    | Logical "0"Input Voltage                    |                         | GND             | 0.6      | V (max)  |  |
| I <sub>IN(1)</sub>    | Logical "1" Input Current                   | $V_{IN} = V_{CC}$       |                 | 2        | μA (max) |  |
| I <sub>IN(0)</sub>    | Logical "0" Input Current                   | $V_{IN} = 0 V$          |                 | -2       | μA (max) |  |
| ALL DIGITA            |   | •                       | •               |          |          |  |
| C <sub>IN</sub>       | Input Capacitance                           |                         | 20              |          | pF       |  |
| ALL DIGITA            | OUTPUTS                                     |                         |                 |          | •        |  |
| I <sub>он</sub>       | High Level Output Current                   | $V_{OH} = V_{CC}$       |                 | 100      | μA (max) |  |
| V <sub>OL</sub>       | SMBus Low Level Output                      | I <sub>OL</sub> = 3 mA  |                 | 0.4      | V (max)  |  |
|                       | Voltage                                     | $I_{OL} = 6 \text{ mA}$ |                 | 0.6      |          |  |

### Logic Electrical Characteristics (Continued)

**SMBus DIGITAL SWITCHING CHARACTERISTICS** Unless otherwise noted, these specifications apply for  $V_{CC}$ =+3.0 Vdc to +3.6 Vdc,  $C_L$  (load capacitance) on output lines = 80 pF. **Boldface limits apply for T<sub>A</sub> = T<sub>J</sub> = T<sub>MIN</sub> to T<sub>MAX</sub>**; all other limits T<sub>A</sub> = T<sub>J</sub> = +25°C, unless otherwise noted. The switching characteristics of the LM83 fully meet or exceed the published specifications of the SMBus or I<sup>2</sup>C bus. The following parameters are the timing relationships between SMBCLK and SMBData signals related to the LM83. They are not the I<sup>2</sup>C or SMBus bus specifications.

| Symbol                | Parameter                           | Conditions               | Typical  | Limits   | Units     |
|-----------------------|-------------------------------------|--------------------------|----------|----------|-----------|
|                       |                                     |                          | (Note 6) | (Note 7) | (Limit)   |
| f <sub>SMB</sub>      | SMBus Clock Frequency               |                          |          | 100      | kHz (max) |
|                       |                                     |                          |          | 10       | kHz (min) |
| t <sub>LOW</sub>      | SMBus Clock Low Time                | 10 % to 10 %             |          | 1.3      | µs (min)  |
|                       |                                     |                          |          | 25       | ms (max)  |
| t <sub>LOW</sub> MEXT | Cumulative Clock Low Extend Time    |                          |          | 10       | ms (max)  |
| t <sub>HIGH</sub>     | SMBus Clock High Time               | 90 % to 90%              |          | 0.6      | µs (min)  |
| t <sub>R,SMB</sub>    | SMBus Rise Time                     | 10% to 90%               | 1        |          | µs (max)  |
| t <sub>F,SMB</sub>    | SMBus Fall Time                     | 90% to 10%               | 0.3      |          | ns (max)  |
| t <sub>OF</sub>       | Output Fall Time                    | C <sub>L</sub> = 400 pF, |          | 250      | ns (max)  |
|                       |                                     | I <sub>O</sub> = 3 mA    |          |          |           |
| t <sub>TIMEOUT</sub>  | SMBData and SMBCLK Time Low for     |                          |          | 25       | ms (min)  |
|                       | Reset of Serial Interface (Note 12) |                          |          | 40       | ms (max)  |
| t <sub>1</sub>        | SMBCLK (Clock) Period               |                          |          | 10       | μs (min)  |
| t <sub>2</sub> ,      | Data In Setup Time to SMBCLK High   |                          |          | 100      | ns (min)  |
| t <sub>SU;DAT</sub>   |                                     |                          |          |          |           |
| t <sub>3</sub> ,      | Data Out Stable after SMBCLK Low    |                          |          | 300      | ns (min)  |
| t <sub>HD;DAT</sub>   |                                     |                          |          | TBD      | ns (max)  |
| t <sub>4</sub> ,      | SMBData Low Setup Time to SMBCLK    |                          |          | 100      | ns (min)  |
| t <sub>HD;STA</sub>   | Low                                 |                          |          |          |           |
| t <sub>5</sub> ,      | SMBData High Delay Time after       |                          |          | 100      | ns (min)  |
| t <sub>SU;STO</sub>   | SMBCLK High (Stop Condition Setup)  |                          |          |          |           |
| t <sub>6</sub> ,      | SMBus Start-Condition Setup Time    |                          |          | 0.6      | µs (min)  |
| t <sub>SU;STA</sub>   |                                     |                          |          |          |           |
| t <sub>BUF</sub>      | SMBus Free Time                     |                          |          | 1.3      | µs (min)  |





#### See drawing DS10105807

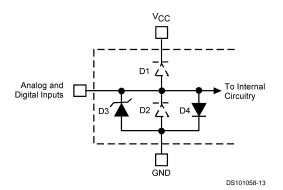
Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. DC and AC electrical specifications do not apply when operating the device beyond its rated operating conditions.

Note 2: When the input voltage  $(V_1)$  at any pin exceeds the power supplies  $(V_1 < \text{GND or } V_1 > V_{CC})$ , the current at that pin should be limited to 5 mA. The 20 mA maximum package input current rating limits the number of pins that can safely exceed the power supplies with an input current of 5 mA to four.

Parasitic components and or ESD protection circuitry are shown in the figure below for the LM83's pins. The nominal breakdown voltage of the zener D3 is 6.5 V. Care should be taken not to forward bias the parasitic diode, D1, present on pins: D+, D–, ADD1 and ADD0. Doing so by more than 50 mV may corrupt a temperature or voltage measurement.

| Pin Name        | D1 | D2 | D3 | D4 |
|-----------------|----|----|----|----|
|                 |    |    |    |    |
| V <sub>cc</sub> |    |    | х  |    |
| D+              | х  | х  | x  |    |
| D-              | х  | х  | x  | х  |
| ADD0, ADD1      | х  | х  | x  |    |

Note: An x indicates that the diode exists.



### FIGURE 1. ESD Protection Input Structure

Note 3: See AN-450 "Surface Mounting Methods and Their Effect on Product Reliability" or the section titled "Surface Mount" found in a current National Semiconductor Linear Data Book for other methods of soldering surface mount devices.

Note 4: Human body model, 100 pF discharged through a 1.5 kΩ resistor. Machine model, 200 pF discharged directly into each pin.

Note 5: Thermal resistance of the QSOP-16 package is xyz\*C/W, junction-to-ambient when attached to a printed circuit board with 2 oz. foil as shown in Figure 3

### Logic Electrical Characteristics (Continued)

**Note 6:** Typicals are at  $T_A = 25^{\circ}C$  and represent most likely parametric norm.

Note 7: Limits are guaranteed to National's AOQL (Average Outgoing Quality Level).

Note 8: The Temperature Error will vary less than ±1.0 °C for a variation in V<sub>CC</sub> of 3 V to 3.6 V from the nominal of 3.3 V.

Note 9: Quiescent current will not increase substantially with an active SMBus.

Note 10: This specification is provided only to indicate how often temperature data is updated. The LM83 can be read at any time without regard to conversion state (and will yield last conversion result).

Note 11: Default values set at power up.

Note 12: Holding the SMBData and/or SMBCLK lines Low for a time interval greater than t<sub>TIMEOUT</sub> will cause the LM83 to reset SMBData and SMBCLK to the IDLE state of an SMBus communication (SMBCLK and SMBData set High).

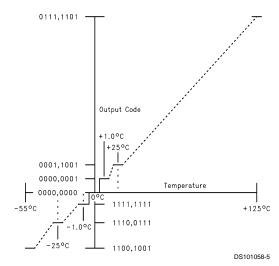


FIGURE 2. Temperature-to-Digital Transfer Function (Non-linear scale for clarity)



FIGURE 3. Printed Circuit Board Used for Thermal Resistance Specifications

### **1.0 Functional Description**

The LM83 temperature sensor incorporates a band-gap type temperature sensor using a Local or three Remote diodes and an 8-bit ADC (Delta-Sigma Analog-to-Digital Converter). The LM83 is compatible with the serial SMBus and I<sup>2</sup>C two wire interfaces. Digital comparators compare Local (LT) and Remote (D1RT, D2RT and D3RT) temperature readings to user-programmable setpoints (LHS, D1RHS, D2RHS, D3RHS and TCS). Activation of the INT output indicates that a comparison is greater than the limit preset in a HIGH register. The T\_CRIT setpoint (TCS) interacts with all the temperature readings. Activation of the T\_CRIT\_A output indicates that any or all of the temperature readings have exceed the T\_CRIT setpoint.

#### **1.1 CONVERSION SEQUENCE**

The LM83 converts its own temperature as well as 3 remote diode temperatures in the following sequence:

1. Local Temperature (LT)

- 1. Remote Diode 2 (D2RT)
- 2. Remote Diode 1 (D1RT)
- 3. Remote Diode 3 (D3RT)

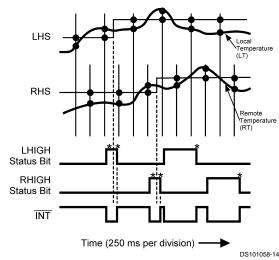
This round robin sequence takes approximately 480 ms to complete as each temperature is digitized in approximately 120 ms.

#### 1.2 INT OUTPUT and T\_HIGH LIMITS

Each temperature reading (LT, D1RT, D2RT, and D3RT) is associated with a T\_HIGH setpoint register (LHS, D1RHS, D2RHS, D3RHS). At the end of a temperature reading a digital comparison determines whether that reading has exceed its HIGH setpoint. If the temperature reading is greater than the HIGH setpoint, a bit is set in one of the Status Registers, to indicate which temperature reading, and the INT output is activated.

Local and remote temperature diodes are sampled in sequence by the A/D converter. The  $\overline{INT}$  output and the Status

Register flags are updated at the completion of a conversion, which occurs approximately 60 ms after a temperature diode is sampled. INT is deactivated when the Status Register, containing the set bit, is read and a temperature reading is less than or equal to it's corresponding HIGH setpoint, as shown in *Figure 4. Figure 5*shows a simplified logic diagram for the INT output and related circuitry.



\* Note: Status Register Bits are reset by a read of Status Register where bit is located.



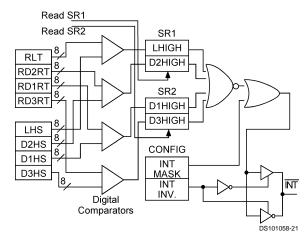
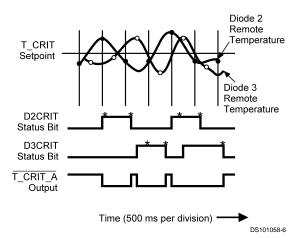


FIGURE 5. INT output related circuitry logic diagram

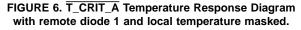
The  $\overline{\text{INT}}$  output can be disabled by setting the  $\overline{\text{INT}}$  mask bit, D7, of the configuration register.  $\overline{\text{INT}}$  can be programmed to be active high or low by the state of the  $\overline{\text{INT}}$  inversion bit, D1, in the configuration register. A "0" would program  $\overline{\text{INT}}$  to be active low.  $\overline{\text{INT}}$  is an open-drain output.

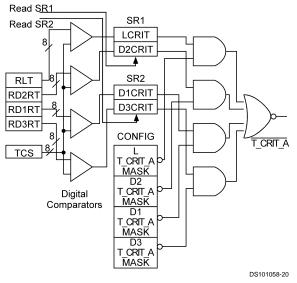
#### 1.3 T\_CRIT\_A OUTPUT and T\_CRIT LIMIT

 $T\_CRIT\_A$  is activated when any temperature reading is greater than the limit preset in the critical temperature setpoint register (T\_CRIT), as shown in *Figure 6*. The Status Registers can be read to determine which event caused the alarm. A bit in the Status Registers is set high to indicate which temperature reading exceeded the T\_CRIT setpoint temperature and caused the alarm, see *Section 2.3*. Local and remote temperature diodes are sampled in sequence by the A/D converter. The  $T\_CRIT\_A$  output and the Status Register flags are updated at the completion of a conversion. T\\_CRIT\\_A and the Status Register flags are reset only after the Status Register is read and if a temperature conversion is below the T\_CRIT setpoint, as shown in *Figure* 6. *Figure* 7 shows a simplified logic diagram of the T\\_CRIT\\_A and related circuitry.



 $^{\ast}$  Note: Status Register Bits are reset by a read of Status Register where bit is located.





#### FIGURE 7. T\_CRIT\_A output related circuitry logic diagram

Located in the Configuration Register are the mask bits for each temperature reading, see *Section 2.5.* When a mask bit is set, its corresponding status flag will not propagate to the  $\overline{T_CRIT_A}$  output, but will still be set in the Status Registers. Setting all four mask bits or programming the  $T_CRIT$  setpoint to 127°C will disable the  $\overline{T_CRIT_A}$  output.

#### 1.4 POWER ON RESET DEFAULT STATES

LM83 always powers up to these known default states:

- 1. Command Register set to 00h
- 2. Local Temperature set to 0°C

LM83

- Diode 1, Diode 2, and Diode 3 Remote Temperature set to 0°C until the LM83 senses a diode present between the D+ and D- input pins.
- 4. Status Registers 1 and 2 set to 00h.
- Configuration Register set to 00h; INT enabled and all T\_CRIT setpoints enabled to activate T\_CRIT\_A.
- 6. Local and all Remote T\_CRIT set to 127°C

#### 1.5 SMBus INTERFACE

The LM83 operates as a slave on the SMBus, so the SMBCLK line is an input (no clock is generated by the LM83) and the SMBData line is bi-directional. According to SMBus specifications, the LM83 has a 7-bit slave address. Bit 4 (A3) of the slave address is hard wired inside the LM83 to a 1. The remainder of the address bits are controlled by the state of the address select pins ADD1 and ADD0, and are set by connecting these pins to ground for a low, (0) , to V<sub>CC</sub> for a high, (1), or left floating (TRI-LEVEL).

| Therefore, | the | complete | slave | address | is: |  |
|------------|-----|----------|-------|---------|-----|--|
|------------|-----|----------|-------|---------|-----|--|

| A6  | A5 | A4 | 1 | A2 | A1 | A0  |
|-----|----|----|---|----|----|-----|
| MSB |    |    |   |    |    | LSB |

and is selected as follows:

| Address Sel | ect Pin State | LM83 SMBus<br>Slave Address |
|-------------|---------------|-----------------------------|
| ADD0        | ADD1          | A6:A0 binary                |
| 0           | 0             | 001 1000                    |
| 0           | TRI-LEVEL     | 001 1001                    |
| 0           | 1             | 001 1010                    |
| TRI-LEVEL   | 0             | 010 1001                    |
| TRI-LEVEL   | TRI-LEVEL     | 010 1010                    |
| TRI-LEVEL   | 1             | 010 1011                    |
| 1           | 0             | 100 1100                    |
| 1           | TRI-LEVEL     | 100 1101                    |
| 1           | 1             | 100 1110                    |

The LM83 latches the state of the address select pins during the first read or write on the SMBus. Changing the state of the address select pins after the first read or write to any device on the SMBus will not change the slave address of the LM83.

#### **1.6 TEMPERATURE DATA FORMAT**

Temperature data can be read from the Local and Remote Temperature, T\_CRIT, and HIGH setpoint registers; and written to the T\_CRIT and HIGH setpoint registers. Temperature data is represented by an 8-bit, two's complement byte with an LSB (Least Significant Bit) equal to 1°C:

| Temperature | Digital Output |     |  |  |  |  |
|-------------|----------------|-----|--|--|--|--|
|             | Binary         | Hex |  |  |  |  |
| +125°C      | 0111 1101      | 7Dh |  |  |  |  |
| +25°C       | 0001 1001      | 19h |  |  |  |  |
| +1°C        | 0000 0001      | 01h |  |  |  |  |
| 0°C         | 0000 0000      | 00h |  |  |  |  |
| −1°C        | 1111 1111      | FFh |  |  |  |  |
| –25°C       | 1110 0111      | E7h |  |  |  |  |
| –55°C       | 1100 1001      | C9h |  |  |  |  |

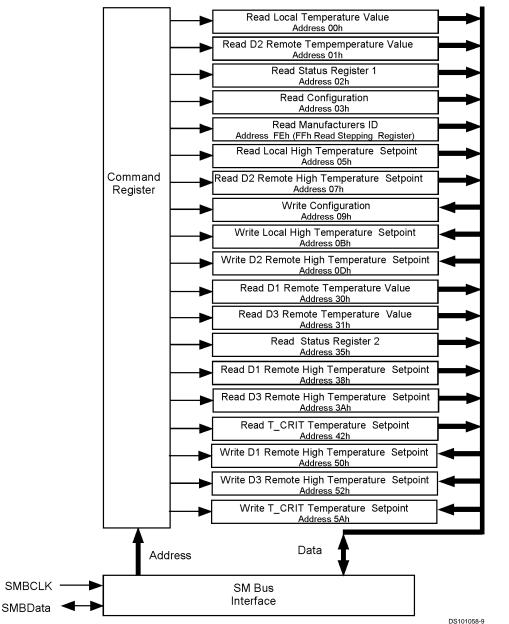
#### 1.7 OPEN-DRAIN OUTPUTS

The SMBData,  $\overline{\text{INT}}$  and  $\overline{\text{T_CRIT_A}}$  outputs are open-drain outputs and do not have internal pull-ups. A "high" level will not be observed on these pins until pull-up current is provided from some external source, typically a pull-up resistor. Choice of resistor value depends on many system factors but, in general, the pull-up resistor should be as large as possible. This will minimize any internal temperature reading errors due to internal heating of the LM83. The maximum resistance of the pull up, based on LM83 specification for High Level Output Current, to provide a 2.1V high level, is  $30k\Omega$ .

#### **1.8 DIODE FAULT DETECTION**

Before each external conversion the LM83 goes through an external diode fault detection sequence. If a D+ input is shorted to  $V_{CC}$  or floating then the temperature reading will be +127 °C, and its OPEN bit in the Status Register will be set. If the T\_CRIT setpoint is set to less than +127 °C then the D+ inputs RTCRIT bit in the Status Register will be set which will activate the T\_CRIT\_A output, if enabled. If a D+ is shorted to GND or D-, its temperature reading will be 0 °C and its OPEN bit in the Status Register will not be set.

#### 1.9 COMMUNICATING with the LM83



LM83

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There are 19 data registers in the LM83, selected by the Command Register. At power-up the Command Register is set to "00", the location for the Read Local Temperature Register. The Command Register latches the last location it was set to. Reading the Status Register resets  $T\_CRIT\_A$  and INT, so long as a temperature comparison does not signal a fault (see *Sections 1.2 and 1.3*). All other registers are predefined as read only or write only. Read and write registers with the same function contain mirrored data.

A **Write** to the LM83 will always include the address byte and the command byte. A write to any register requires one data byte.

Reading the LM83 can take place either of two ways:

1. If the location latched in the Command Register is correct (most of the time it is expected that the Command Register will point to one of the Read Temperature Registers because that will be the data most frequently read from the LM83), then the read can simply consist of an address byte, followed by retrieving the data byte.

2. If the Command Register needs to be set, then an address byte, command byte, repeat start, and another address byte will accomplish a read.

The data byte has the most significant bit first. At the end of a read, the LM83 can accept either Acknowledge or No Acknowledge from the Master (No Acknowledge is typically used as a signal for the slave that the Master has read its last byte).

#### **1.10 SERIAL INTERFACE ERROR RECOVERY**

The LM83 SMBus lines will be reset to the SMBus idle state if the SMBData or SMBCLK lines are held low for 40 ms or more ( $t_{\text{TIMEOUT}}$ ). The LM83 may or may not reset the state of

the serial interface logic if either of the SMBData or SMBCLK lines are held low between 25 ms and 40 ms. TIMEOUT allows a clean recovery in cases where the master may be reset while the LM83 is transmitting a low bit thus preventing possible bus lock up.

Whenever the LM83 sees the start condition its serial interface will reset to the beginning of the communication, thus the LM83 will expect to see an address byte next. This simplifies recovery when the master is reset while the LM83 is transmitting a high.

### 2.0 LM83 REGISTERS

### 2.1 COMMAND REGISTER

Selects which registers will be read from or written to. Data for this register should be transmitted during the Command Byte of the SMBus write communication.

| P7 | P6 | P5 | P4  | P3 | P2 | P1 | P0 |  |
|----|----|----|---|----|----|----|----|--|
| 0  |    |    | P5     P4     P3     P2     P1       Command Select |    |    |    |    |  |

P0-P7: Command Select

| Command Se-<br>lect Address | Power On D             | efault State                  | Register Name | Register Function                |  |
|-----------------------------|------------------------|-------------------------------|---------------|----------------------------------|--|
| <p7:p0> hex</p7:p0>         | <d7:d0> binary</d7:d0> | <d7:d0> deci-<br/>mal</d7:d0> |               |                                  |  |
| 00h                         | 0000 0000              | 0                             | RLT           | Read Local Temperature           |  |
| 01h                         | 0000 0000              | 0                             | RD2RT         | Read D2 Remote<br>Temperature    |  |
| 02h                         | 0000 0000              | 0                             | RSR1          | Read Status Register 1           |  |
| 03h                         | 0000 0000              | 0                             | RC            | Read Configuration               |  |
| 04h                         | 0000 0000              | 0                             |               | Reserved                         |  |
| 05h                         | 0111 1111              | 127                           | RLHS          | Read Local HIGH Setpoint         |  |
| 06h                         |                        |                               |               | Reserved                         |  |
| 07h                         | 0111 1111              | 127                           | RD2RHS        | Read D2 Remote HIGH<br>Setpoint  |  |
| 08h                         |                        |                               |               | Reserved                         |  |
| 09h                         | 0000 0000              |                               | WC            | Write Configuration              |  |
| 0Ah                         |                        |                               |               | Reserved                         |  |
| 0Bh                         | 0111 1111              | 127                           | WD2LHS        | Write Local HIGH Setpoint        |  |
| 0Ch                         |                        |                               |               | Reserved                         |  |
| 0Dh                         | 0111 1111              | 127                           | WD2RHS        | Write D2 Remote HIGH<br>Setpoint |  |
| 0Eh-2Fh                     |                        |                               |               | Reserved for Future Use          |  |
| 30h                         | 0000 0000              | 0                             | RD1RT         | Read D1 Remote<br>Temperature    |  |
| 31h                         | 0000 0000              | 0                             | RD3RT         | Read D3 Remote<br>Temperature    |  |
| 32h-34h                     |                        |                               |               | Reserved for Future Use          |  |
| 35h                         | 0000 0000              | 0                             | RSR2          | Read Status Register 2           |  |
| 36h-37h                     |                        |                               |               | Reserved for Future Use          |  |
| 38h                         | 0111 1111              | 127                           | RD1RHS        | Read D1 Remote HIGH<br>Setpoint  |  |
| 39h                         |                        |                               |               | Reserved for Future Use          |  |
| 3Ah                         | 0111 1111              | 127                           | RD3RHS        | Read D3 Remote HIGH<br>Setpoint  |  |
| 3Bh-41h                     |                        |                               |               | Reserved for Future Use          |  |
| 42h                         | 0111 1111              | 127                           | RTCS          | Read T_CRIT Setpoint             |  |
| 43h-4Fh                     |                        |                               |               | Reserved for Future Use          |  |
| 50h                         | 0111 1111              | 127                           | WD1RHS        | Write D1 Remote HIGH<br>Setpoint |  |
| 51h                         |                        |                               |               | Reserved for Future Use          |  |
| 52h                         | 0111 1111              | 127                           | WD3RHS        | Write D3 Remote HIGH<br>Setpoint |  |
| 53h-59h                     |                        |                               |               | Reserved for Future Use          |  |
| 5Ah                         | 0111 1111              | 127                           | WTCS          | Write T_CRIT Setpoint            |  |

| Command Se-<br>lect Address | Power On D             | efault State                  | Register Name | Register Function                     |
|-----------------------------|------------------------|-------------------------------|---------------|---------------------------------------|
| <p7:p0> hex</p7:p0>         | <d7:d0> binary</d7:d0> | <d7:d0> deci-<br/>mal</d7:d0> |               |                                       |
| 5Ch-6Fh and<br>F0h-FDh      |                        |                               |               | Reserved for Future Use               |
| FEh                         | 0000 0001              | 1                             | RMID          | Read Manufacturers ID                 |
| FFh                         |                        |                               | RSR           | Read Stepping or Die<br>Revision Code |

#### **2.2 LOCAL and D1, D2 and D3 REMOTE TEMPERATURE REGISTERS (LT, D1RT, D2RT, and D3RT)** (Read Only Address 00h, 01h, 30h and 31h):

|     | -     |       |       |       |       |       |     |
|-----|-------|-------|-------|-------|-------|-------|-----|
| D7  | D6    | D5    | D4    | D3    | D2    | D1    | D0  |
| MSB | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | LSB |

D7–D0: Temperature Data. One LSB = 1°C. Two's complement format.

#### 2.3 STATUS REGISTERS 1 and 2

2.3.1 Status Register 1 (SR1) (Read Only Address 02h):

| D7 | D6    | D5 | D4      | D3 | D2     | D1     | D0    |
|----|-------|----|---------|----|--------|--------|-------|
| 0  | LHIGH | 0  | D2RHIGH | 0  | D2OPEN | D2CRIT | LCRIT |

Power up default is with all bits "0" (zero).

D0: LCRIT: When set to a 1 indicates an Local Critical Temperature alarm.

D1: D2CRIT: When set to a 1 indicates a Remote Diode 2 Critical Temperature alarm.

D2: D2OPEN: When set to 1 indicates a Remote Diode 2 disconnect.

D4: D2RHIGH: When set to 1 indicates a Remote Diode 2 HIGH Temperature alarm.

D6: LHIGH: When set to 1 indicates a Local HIGH Temperature alarm.

D7, D5, and D3: These bits are always set to 0 and reserved for future use.

### **Status Register 2**

2.3.2 Status Register 2 (SR2) (Read Only Address 35h):

| D7      | D6 | D5     | D4             | D3 | D2     | D1     | D0     |
|---------|----|--------|----------------|----|--------|--------|--------|
| D1RHIGH | 0  | D10PEN | <b>D3RHIGH</b> | 0  | D3OPEN | D3CRIT | D1CRIT |

Power up default is with all bits "0" (zero).

D0: D1CRIT, when set to 1 indicates a Remote Diode 1 Critical Temperature alarm.

D1: D3CRIT, when set to 1 indicates a Remote Diode 3 Critical Temperature alarm.

D2: D3OPEN, when set to 1 indicates a Remote Diode 3 disconnect.

D4: D3RHIGH, when set to 1 indicates a Remote Diode 3 HIGH Temperature alarm.

D5: D1OPEN, when set to 1 indicates a Remote Diode 1 disconnect.

D7: D1RHIGH, when set to 1 indicates a Remote Diode 1 HIGH Temperature alarm.

D6, and D3: These bits are always set to 0 and reserved for future use.

#### 2.4 MANUFACTURERS ID REGISTER

(Read Address FEh) Default value 01h.

#### 2.5 CONFIGURATION REGISTER

(Read Address 03h/Write Address 09h):

| D7       | D6 | D5                     | D4                     | D3                     | D2                        | D1            | D0 |
|----------|----|------------------------|------------------------|------------------------|---------------------------|---------------|----|
| INT mask | 0  | D1<br>T_CRIT_A<br>mask | D2<br>T_CRIT_A<br>mask | D3<br>T_CRIT_A<br>mask | Local<br>T_CRIT_A<br>mask | INT Inversion | 0  |

Power up default is with all bits "0" (zero).

D7: INT mask: When set to 1 INT interrupts are masked.

-M83

D5: T\_CRIT mask for Diode 1, when set to 1 a Diode 1 temperature reading that exceeds T\_CRIT setpoint will not activate the T\_CRIT\_A pin.

<u>D4:</u> T\_CRIT mask for Diode 2, when set to 1 a Diode 2 temperature reading that exceeds T\_CRIT setpoint will not activate the T\_CRIT\_A pin.

<u>D3:</u> T\_CRIT mask for Diode 3, when set to 1 a Diode 3 temperature reading that exceeds T\_CRIT setpoint will not activate the  $T_{CRIT_A}$  pin.

D2: T\_CRIT mask for Local reading, when set to 1 a Local temperature reading that exceeds T\_CRIT setpoint will not activate the T\_CRIT\_A pin.

D1: INT active state inversion. When INT Inversion is set to a 1 the active state of the INT output will be a logical high. A low would then select an active state of a logical low.

D6 and D0: These bits are always set to 0 and reserved for future use. A write of 1 will return a 0 when read.

#### 2.6 LOCAL, DIODE 1, DIODE 2 and DIODE 3 HIGH SETPOINT REGISTERS (LHS, D1RHS, D2RHS and D3RHS)

(Read Address 05h, 07h, 38h, 3Ah /Write Address 0Bh, 0Dh, 50h, 52h):

| D7  | D6    | D5    | D4    | D3    | D2    | D1    | D0  |
|-----|-------|-------|-------|-------|-------|-------|-----|
| MSB | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | LSB |

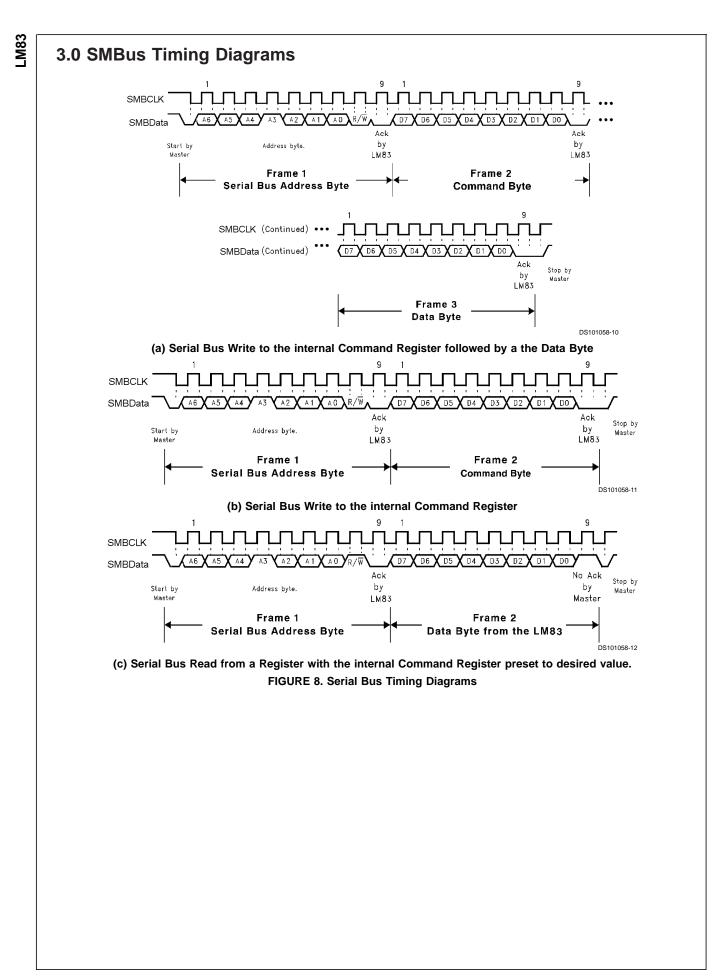
D7-D0: HIGH setpoint temperature data. Power up default is LHIGH = RD1HIGH=RD2HIGH=RD3HIGH = 127°C.

#### 2.7 T\_CRIT REGISTER (TCS)

(Read Address 42h/Write Address 5Ah):

| D7  | D6    | D5    | D4    | D3    | D2    | D1    | D0  |
|-----|-------|-------|-------|-------|-------|-------|-----|
| MSB | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | LSB |

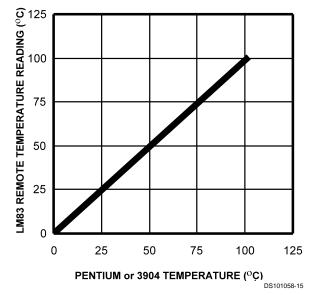
D7–D0: T\_CRIT setpoint temperature data. Power up default is T\_CRIT = 127°C.



### 4.0 Application Hints

The LM83 can be applied easily in the same way as other integrated-circuit temperature sensors, and its remote diode sensing capability allows it to be used in new ways as well. It can be soldered to a printed circuit board, and because the path of best thermal conductivity is between the die and the pins, its temperature will effectively be that of the printed circuit board lands and traces soldered to the LM83's pins. This presumes that the ambient air temperature is almost the same as the surface temperature of the printed circuit board; if the air temperature is much higher or lower than the surface temperature, the actual temperature of the of the LM83 die will be at an intermediate temperature between the surface and air temperatures. Again, the primary thermal conduction path is through the leads, so the circuit board temperature will contribute to the die temperature much more strongly than will the air temperature.

To measure temperature external to the LM83's die, use a remote diode. This diode can be located on the die of a target IC, allowing measurement of the IC's temperature, independent of the LM83's temperature. The LM83 has been optimized to measure the remote diode of a Pentium II processor as shown in *Figure 9*. A discrete diode can also be used to sense the temperature of external objects or ambient air. Remember that a discrete diode's temperature will be affected, and often dominated, by the temperature of its leads.



#### Pentium or 3904 Temperature vs LM83 Temperature Reading

Most silicon diodes do not lend themselves well to this application. It is recommended that a 2N3904 transistor base emitter junction be used with the collector tied to the base.

A diode connected 2N3904 approximates the junction available on a Pentium microprocessor for temperature measurement. Therefore, the LM83 can sense the temperature of this diode effectively.

## 3.1 ACCURACY EFFECTS OF DIODE NON-IDEALITY FACTOR

The technique used in today's remote temperature sensors is to measure the change in  $V_{BE}$  at two different operating points of a diode. For a bias current ratio of N:1, this difference is given as:

$$\Delta V_{BE} = \eta \, \frac{kT}{q} \ln(N)$$

where:

- η is the non-ideality factor of the process the diode is manufactured on,
- q is the electron charge,
- k is the Boltzmann's constant,
- N is the current ratio,
- T is the absolute temperature in °K.

The temperature sensor then measures  $\Delta V_{BE}$  and converts to digital data. In this equation, k and q are well defined universal constants, and N is a parameter controlled by the temperature sensor. The only other parameter is  $\eta$ , which depends on the diode that is used for measurement. Since  $\Delta V_{BE}$  is proportional to both  $\eta$  and T, the variations in  $\eta$  cannot be distinguished from variations in temperature. Since the non-ideality factor is not controlled by the temperature sensor, it will directly add to the inaccuracy of the sensor. For the Pentium II Intel specifies a ±1% variation in  $\eta$  from part to part. As an example, assume a temperature sensor has an accuracy specification of ±3 °C at room temperature of 25 °C and the process used to manufacture the diode has a non-ideality variation of ±1%. The resulting accuracy of the temperature sensor at room temperature will be:

The additional inaccuracy in the temperature measurement caused by  $\eta$ , can be eliminated if each temperature sensor is calibrated with the remote diode that it will be paired with.

#### 3.2 PCB LAYOUT for MINIMIZING NOISE

In a noisy environment, such as a processor mother board, layout considerations are very critical. Noise induced on traces running between the remote temperature diode sensor and the LM83 can cause temperature conversion errors. The following guidelines should be followed:

- 1. Place a 0.1  $\mu$ F power supply bypass capacitor as close as possible to the V<sub>CC</sub>pin and the recommended 2.2 nF capacitor as close as possible to the D+ and D- pins. Make sure the traces to the 2.2nF capacitor are matched.
- 2. The recommended 2.2nF diode bypass capacitor actually has a range of 200pF to 3.3nF. The average temperature accuracy will not degrade. Increasing the capacitance will lower the corner frequency where differential noise error affects the temperature reading thus producing a reading that is more stable. Conversely, lowering the capacitance will increase the corner frequency where differential noise error affects the temperature reading the stable.
- 3. Ideally, the LM83 should be placed within 10cm of the Processor diode pins with the traces being as straight, short and identical as possible. Trace resistance of  $1\Omega$  can cause as much as 1°C of error.
- 4. Diode traces should be surrounded by a GND guard ring to either side, above and below if possible. This GND guard should not be between the D+ and D- lines. In the event that noise does couple to the diode lines it would be ideal if it is coupled common mode. That is equally to the D+ and D- lines.(See Figure 10)
- 5. Avoid routing diode traces in close proximity to power supply switching or filtering inductors.

LM83

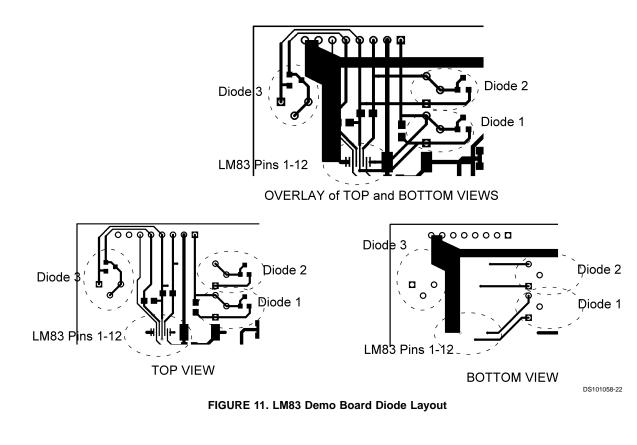
### 4.0 Application Hints (Continued)

- Avoid running diode traces close to or parallel to high speed digital and bus lines. Diode traces should be kept at least 2cm. apart from the high speed digital traces.
- 7. If it is necessary to cross high speed digital traces, the diode traces and the high speed digital traces should cross at a 90 degree angle.
- The ideal place to connect the LM83's GND pin is as close as possible to the Processors GND associated with the sense diode. For the Pentium II this would be pin A14.
- Leakage current between D+ and GND should be kept to a minimum. One nano-ampere of leakage can cause as much as 1°C of error in the diode temperature reading. Keeping the printed circuit board as clean as possible will minimize leakage current.

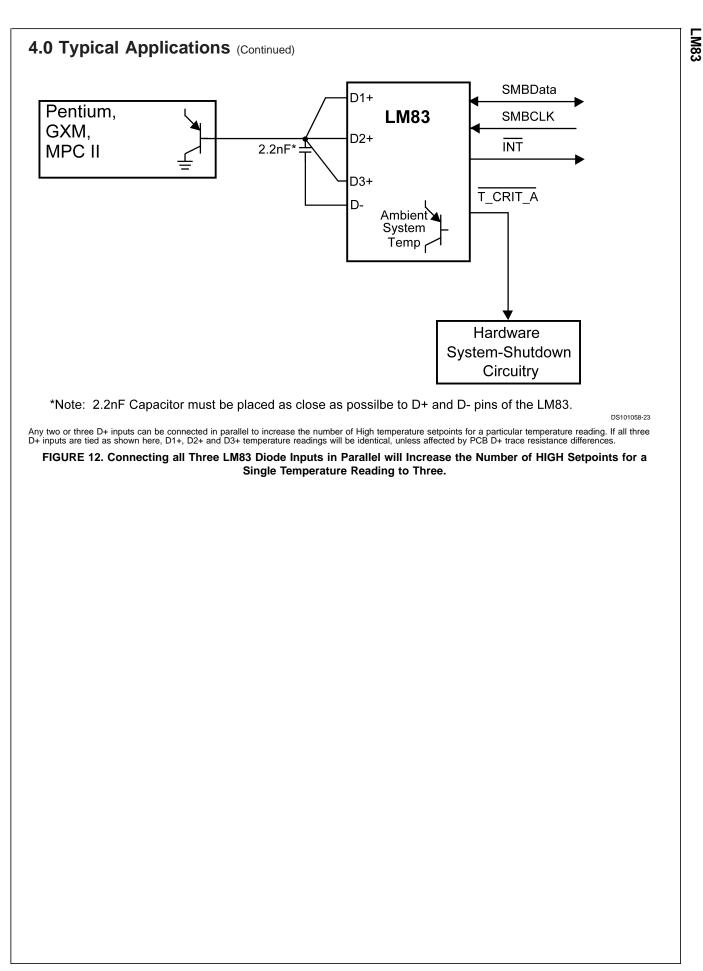


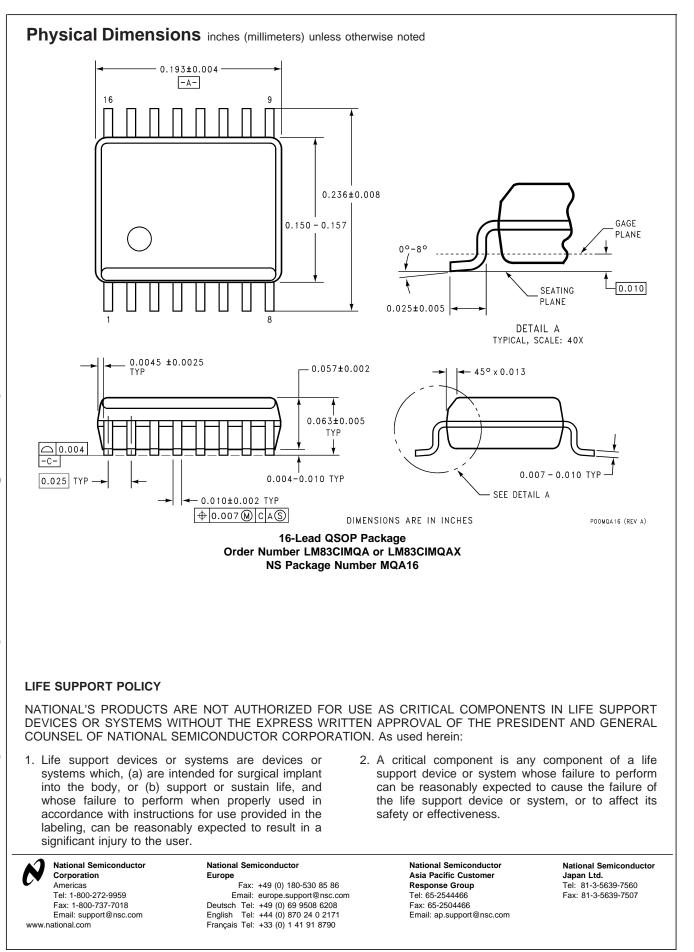
FIGURE 10. Ideal Diode Trace Layout

Noise coupling into the digital lines greater than 300mVp-p (typical hysteresis), overshoot greater than 500mV above V<sub>CC</sub>, and undershoot less than 500mV below GND, may prevent successful SMBus communication with the LM83. SM-Bus no acknowledge is the most common symptom, causing unnecessary traffic on the bus. Although, the SMBus maximum frequency of communication is rather low (100kHz max) care still needs to be taken to ensure proper termination within a system with multiple parts on the bus and long printed circuit board traces. An R/C lowpass filter with a 3db corner frequency of about 40MHz has been included on the LM83's SMBCLK input. Additional resistance can be added in series with the SMBData and SMBCLK lines to further help filter noise and ringing. Minimize noise coupling by keeping digital traces out of switching power supply areas as well as ensuring that digital lines containing high speed data communications cross at right angles to the SMBData and SMBCLK lines.



### 4.0 Typical Applications





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